

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Michael Bauer et al.
Serial No.: 10/565,259
(Priority Application No. 10 2004 025 279.3)
(International Application No. PCT/DE2005/000892)
Filed: January 19, 2006
(Priority Date 19 May 2004)
(International Filing Date 17 May 2005)
Docket No.: I431.145.101/FIN 606 PCT
Title: SUPPORT WITH SOLDER BALL ELEMENTS AND A METHOD FOR
POPULATING SUBSTRATES WITH SOLDER BALLS

SUPPLEMENTAL PRELIMINARY AMENDMENT

Mail Stop Missing Requirements
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This Preliminary Amendment amends the Utility Patent Application filed on January 19, 2006, and should be used to calculate filing fees due. Prior to examination of the above-identified patent application, please amend as follows: